Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste	-	-	
2		Top Overlay			
3		Top Solder	Solder Resist	1,00mil	3,5
4		Top Layer	Copper	1,40mil	
5		Dielectric 1	FR-4	60,00mil	4,6
6		Bottom Layer	Copper	1,40mil	
7		Bottom Solder	Solder Resist	1,00mil	3,5
8		Bottom Overlay			
9		Bottom Paste			
Height: 64,80mil					